

# **Soldering Profile of Conductive Polymer SMD Type**

#### Recommended Land Pattern and Size

pad

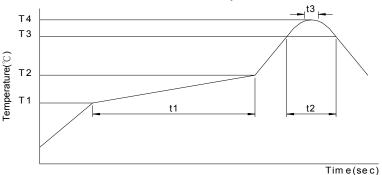
Unit: mm

			Offic. Hilli	
Case size	Land size			
0036 3126	а	b	С	
5φ	1.4	3.0	1.6	
6.3φ	1.9	3.5	1.6	
8φ	3.0	3.5	2.5	
10φ	4.0	4.0	2.5	

## Recommended Soldering Methods

Method	Reflow soldering	Soldering iron	Flow soldering
Advisability	Recommended	Recommended	Not Recommended

## Reflow Profile for Pb-free Assembly



## Test Conditions

Туре		Conductive Polymer	
Preheat	Temp. (T1 ~ T2°C)	150 ~ 200	
Freneat	Time(t1) (Max, Sec)	180	
Duration	Temp. (T3, ℃)	230	
	Time(t2) (Max, Sec)	60	
Peak	Temp (T4, ℃)	250	260
	Time (t3, Sec)	5	
Reflow cycles		2	1

#### (1) Method is as follows.

Reflow soldering condition.

The following temperature profile condition should be observed for soldering. (For higher temperature, pleases contact us after measuring the capacitor's product temperature profile at your side.

Product temperature will rise slower as the product size gets bigger. It is not necessary to adjust the reflow furnace temperature setting according to the product size, for example,  $\phi 4$  and  $\phi 10$  products can be mixed on one PCB for reflowing.

#### (2) Soldering precautions

- Elements related to the reflow soldering temperature
  - \* Product size: The temperature rises slower as the size gets bigger.
  - \* Product location: The center part of the PCB tends to have a lower temperature than the PCB edges.
  - \* PCB size: The PCB temperature rises slower as the area and/or thickness of the PCB gets greater.

# 2. Repeated reflowing

- \* Avoid reflowing twice if possible.
- \* If repeated reflowing is unavoidable, contact us after measuring the first and the second reflow profiles and reflow interval at your side.
- \* Do not attempt to reflow three times.
- 3. Soldering with soldering iron observe the following conditions.
  - \* The iron tip temperature:  $350 \pm 5^{\circ}$ C
  - \* Soldering time: 3 +1 / -0 seconds.

- \* Please contact our representative if your condition is higher.
- \* Please ensure that the capacitor became cold enough to the room temperature (5 ~ 35°C) before the second reflow.
- \* Consult with us when performing reflow profile in IPC / JEDEC (J-STD-020)

### Attention for Conductive Polymer Capacitors

Reflow soldering may reduce the capacitance of products before or after soldering even if soldering conditions stipulated in Recommendable Reflow Condition are met.

Though the actual reflow conditions are subject to change depending on the kind of reflow soldering method, please be aware that the peak temperature at the top of Al-case and electrode terminals should not exceed peak temperature.

Particular notice should be given to the time that Conductive Polymer Capacitors is heated at 200℃ or higher during reflow.

If your reflow conditions (temperature and/or duration) exceed the above, Conductive Polymer Capacitors may be damaged exhibiting; 50% decrease in capacitance, an increase of leakage current, (up to several mA) as well as damage to the exterior of the capacitor.